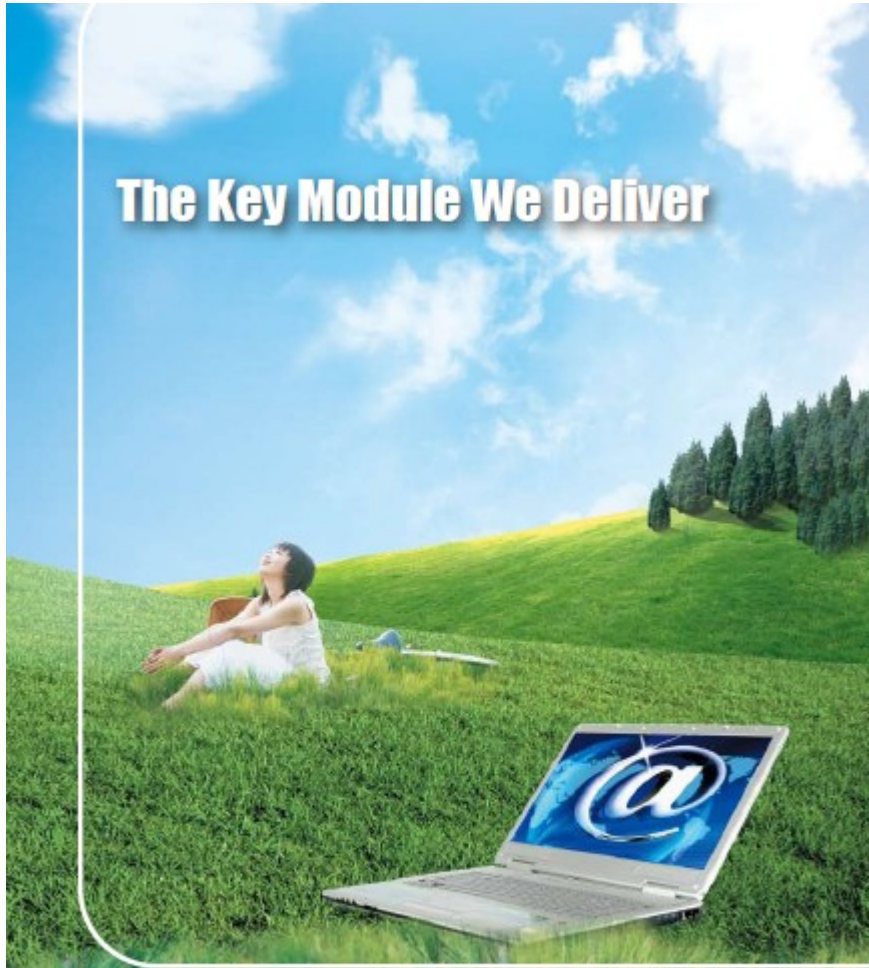


The Key Module We Deliver



Digital Video Recorder



Digital Video Recorder

Model: SDVR04C
 Video Format: H.264
 4 Channel camera
 Camera Lens: CMOS 1/4" Sensor
 90°(Front Cam), 150°(Left, Right, Cam)
 120°(Rear Cam)
 Recording Quality: VGA, QVGA
 Camera Lux: 0.5 LUX
 φ3.5 mm Phone Jack
 Operation Interface: OSD
 Storage: SD Card/SATA HDD (option)
 Built in 750mA Li-on battery, G-Sensor
 Power: DC 12V

Digital Video Recorder

Model: SAP 165C
 CMOS Sensor
 Chip: Aptina MT9V136
 Image array: Optical format 1/4 Inch
 Image area: 3.54(H) X 2.69 (V) mm
 Frame Rate: 30fps NTSC/ 25fps PAL
 Sensitivity: Pixel size: 5.6 um x 5.6um
 Pixel Dynamic range: 82Db
 Responsivity: 11.5V / lux-sec (550nm)
 Overlay: Up to 4 layers
 Mechanical: 16.5mm

Digital Video Recorder

Model: SDVR02C
 Video Format: H.264 / MPEG4
 2 Channel camera
 Camera Lens: CMOS 1/6" Sensor
 90°(Front Cam), 120°(Rear Cam)
 Recording Quality: 720P, VGA, QVGA
 Camera Lux: 0.5 LUX
 Built in MIC and Speaker
 Operation Interface: 2.4 LCD
 Storage: SD Card
 Built in 750mA Li-on battery, G-Sensor
 Power: DC 5.0V

GPS Receiver / Engine



Model: Mars700Mini-TMC
 Chip: SIRF III LP
 TMC: GNS TC5000
 20ch -159dBm
 Dimension: 41 x 36 x 15 mm

GPS TMC Receiver



Model: Mars700pMini	Model: Mars740pMini
Chip: SIRF III LP	Chip: SIRF IV GSD4e
20ch -159dBm	48ch -163dBm
Dimension: 41 x 36 x 15 mm	Dimension: 41 x 36 x 15 mm

GPS Receiver



Model: SSF2929P	Model: S4F2929P
Chip: SIRF III GSC3F	Chip: SIRF IV
20ch -159dBm	48ch -163dBm
RS232/TTL Interface	RS232/TTL Interface
Dimension: 29x29x8 mm	Option: TMC
	Dimension: 29x29x10 mm

GPS Engine

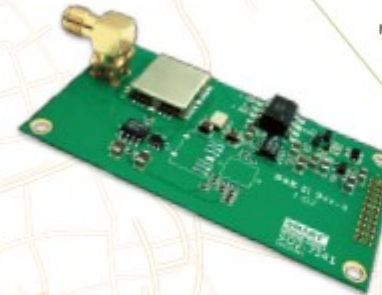


Model: SSF1919P
Chip: SIRF III LP
20ch -163dBm
TTL Interface
Dimension: 19 x 19 x 5 mm

GPS Engine

GPS Dead Reckoning Module

SDR3621



Model: SO27141
 Chip: O2 Micro CB1633B1N-A
 24ch-163dBm
 Ultra fast cool boot 6 - 14 sec.
 Support UART port
 Dimension: 71 x 41 x 17 mm

GPS Module

Model: S4F1513
Chip: SIRF IV
48ch -163dBm
Dimension: 15 x 13 x 2.6 mm

GPS Module

Model: SO21513
Chip: O2 Micro CB1633B1N-A
24ch-163dBm
Ultra fast cool boot 6 - 14 sec.
Support UART, USB, SPI, I2C ports
Dimension: 16.0 x 13.0 x 2.9 mm

Wireless Module



MB-C04

Model: MBC04/MBC041
Chip: CSR BC4
Bluetooth: 2.1 + EDR
Range: Class2 / Class 1
UART Interface
Profile: SPP, HCI
Dimension: 21.5 x 15 x 3mm

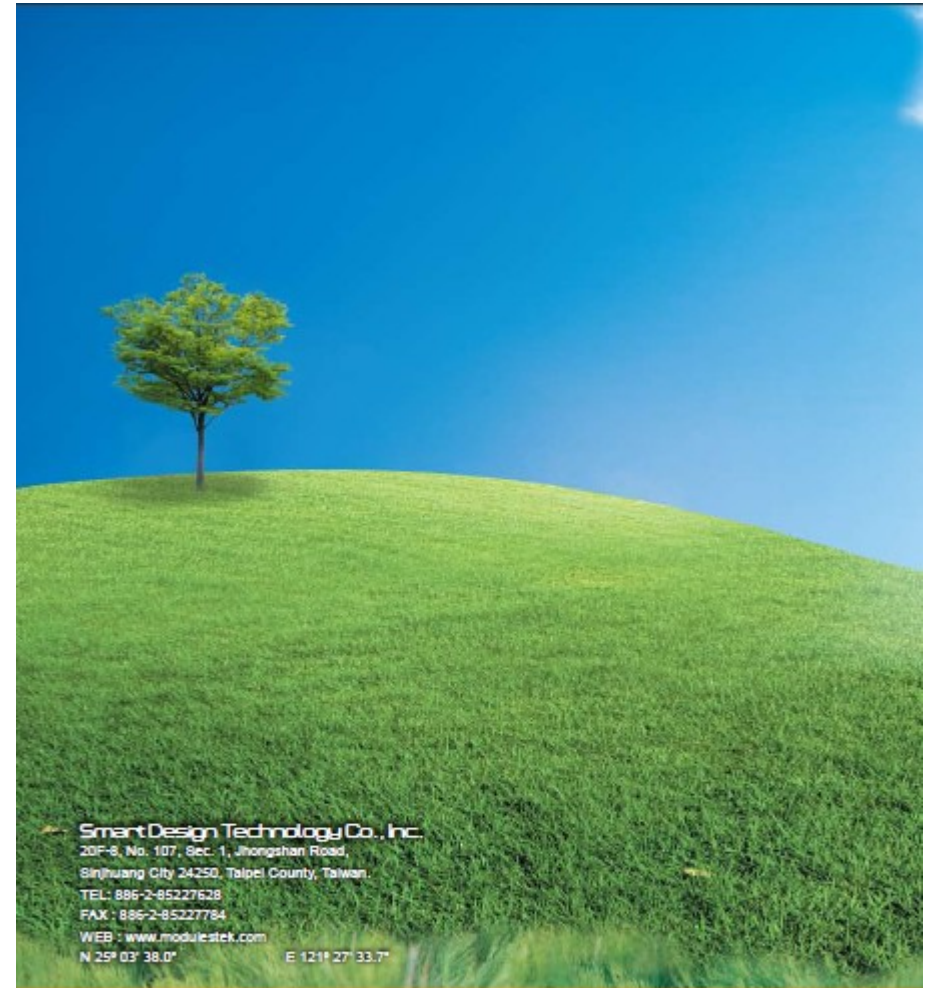


MB-C06

Model: MBC05-CAR / MBC05
Chip: CSR BC5 (need photo)
Bluetooth: 2.1 + EDR
Range: Class 2
UART Interface
Profile(MBC05-CAR): A2DP/HSP/HFP/
AVRCP/PBAP
Profile(MBC05): A2DP/HSP/HFP/
AVRCP/SPP
Dimension (MBC05-CAR): 35 x 25 x 2.7mm
Dimension (MBC05): 12.5 x 12.5 x 2.2mm

Model: SWUM

Ultra Low Power Embedded Module
Standard: WIFI 802.11b/g
Operating Channels: 1-14
11 GPIOs, Sensor Interface
RX Sensitivity: -85dBm
Integrated-on-board,
UFL and Embedded antenna
Infrastructure and Ad-Hoc mode support
Sleep mode support
Power (Active): 30m~200mA
Power (Sleep): 0.5mA



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